Further queries on tender notification for the procuremennt of a CPU+GPU cluster for high performance computing.

S. No.	Query	Response
1.	Due to the global shortage of semiconductor the usual delivery timeline for most of the OEM will be 16 weeks from the date of PO received. Hence request you to kindly amend the delivery term to 16 weeks instead of 8 weeks.	We believe 6-8 weeks is sufficient time to get most of the OEM. As mentioned in the tender, please specify the tentative delivery and installation date in the technical bid.
2.	Kindly confirm if we need to provide the commericals for the 2 ton AC or we just need to submit the BTU report only and as per our understanding the 2 ton AC will not be sufficient for 23 TFLOPS HPC cluster. Hence we seek more clarification to prepare our response on the same	Please submit only the BTU/hr report for the proposed HPC system.
3.	Due to COVID crisis most of the vendors and OEM are not fully operational, hence requesting you to kindly extend the bidding date by further 2 weeks, so that it will help the bidders to participate in this bid.	The tender was uploaded on 27 th August 2021 with a one week time frame for vendors to request clarification, and the clarifications to vendor queries were posted on 7 th September 2021. From this point, the vendors have an additional two weeks to prepare the bid. We belive that this is sufficient time to participate in the bid and an extension is not warranted.
4.	There is no information on the PBG and EMD in the tender. Kindly provide the details on the same whether we need to submit the PBG adn EMD for this bid.	No earnest money deposit (EMD) and performance bank gaurantee (PBG) is required to participate in this bid. As per the tender, the payment would be made to the bidder only after successful installation and testing of the equipment.
5.	Kindly provide the clarification on the late delivery if it applicable for this bid.	There is currently no late delivery clause for this bid.